



Product Change Notification

Change Notification #: 115969 - 00
Change Title: Intel® Server System HNS2600KPFR,
Intel® Server System HNS2600KPR,
Intel® Server System HNS2600TP24R,
Intel® Server System HNS2600TP24SR,
Intel® Server System HNS2600TP24STR,
Intel® Server System HNS2600TPFR,
Intel® Server System HNS2600TPR,
PCN 115969-00, Product Design, Change
node screw hole opening from round to oval
Date of Publication: November 30, 2017

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	December 15, 2017
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems listed on the Products Affected table.

1. Change the screw hole openings of the node tray from round to oval shape to reduce the stress caused to the bridge board when assembling the node. Please see from Figure-1 to Figure-4 below for details

Figure-1: Node screw holes locations (Front View)

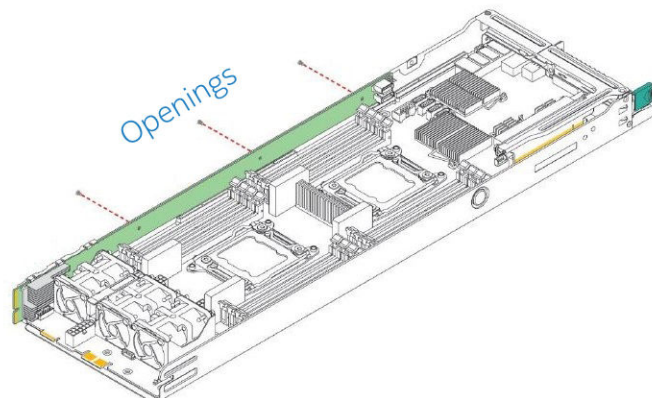


Figure-2: Node screw holes locations (Lateral View)

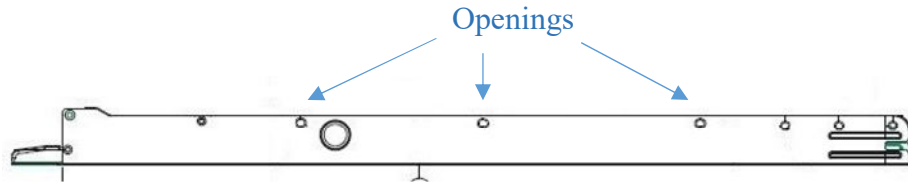
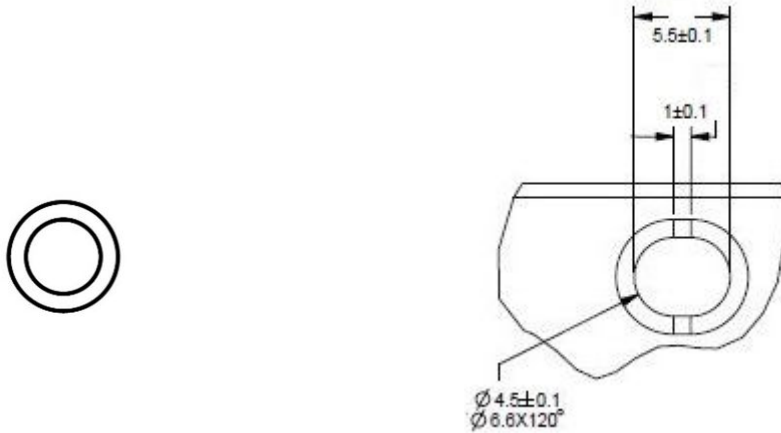


Figure-3: Node screw hole opening (Pre-Change)

Figure-4: Node screw hole opening (Post-Change)



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
HNS2600KPR	943787	H94936-005	H94936-006
HNS2600KPFR	943788	H94937-004	H94937-005
HNS2600TPR	943948	H94938-005	H94938-006
HNS2600TPFR	943949	H94939-005	H94939-005
HNS2600TP24R	943951	H94945-004	H94945-005
HNS2600TP24SR	945609	H93804-004	H93804-005
HNS2600TP24STR	953190	J39063-001	J39063-002

PCN Revision History:

Date of Revision:

November 30, 2017

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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